Contact Name Title - Contact Product-Env-Stewards Authorized Representative* Product-Env-Stewards Product Enviro Compliance Title - Representative Phone - Contact* Phone - Contact* Product-Env-Stewards@onsemi.com Phone - Representative* Phone - Representative* Phone - Representative* Product-Env-Stewards Product-Env-Stewards@onsemi.com Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM	IPC ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIES	Material Compos © Copyright 2005. IPC international and Pan-A	C, Bannockb	urn, Illinois. A	All rights reserved un ntions.	der both	This docume level parts, th	nt is a declaration e	on of the suncompasse	ubstances s all lower	within the manufactur level materials for w	rer listed ite hich the ma	m. Note: i	f the item is an as r has engineering	sembly with lov responsibility.
Company name* Company unique ID Unique ID Authority Response Date* 2025-06-04 2025-06-04 2025-06-04 Contact Name Title - Contact* Product Enviro Compliance NA Product-Env-Stewards Product	752-21.1									als and Mfg	Informati	ion			
Semil	upplier Inform	nation				·		·							
Title - Contact Name Product Envisor Compliance NA Product Envisor Email - Representative* Product Envisor Compliance NA Product Envisor Email - Representative*	Company name* Company unique ID					Unique ID Authority				Response Date*					
Product-Env-Stewards	nsemi											2025-06-0	4		
Authorized Representative* Product-Env-Stewards Requester Item Number Requester Item Num	ontact Name			Title - Conta	ct		I	Phone - Contac	et*			Email - C	ontact*		
Product Enviro Compliance Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM MTANUMENTALITY MANUMENTALITY MANUMENTA	Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Authorized Representative* Title - R				tle - Representative			Phone - Representative*			Email - Representative*				
NCV303LSN44T1G ANA UNDERVOLT DETECT 3.0V 2025-06-04 MY1 14.08 mg	Product-Env-Stewards Product Enviro				ro Compliance			NA				Product-Env-Stewards@onsemi.com			
Manufacturing Proccess Information Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3	Requeste	er Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site	W	eight*	UOM	Unit Type
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3			NCV303	LSN44T1G	ANA UNDERVOI	LT DETECT 3	.0V	2025-06-04		N	ЛY1	14	.08	mg	Each
Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3 comments				arminal Paga	Alloy	STD 020 MSI	Dating	Dook Prog	oss Pody T	amparatur	May Time at Peak	Tomporatu	o Numb	per of Poflow Cyc	Jac
omments					Alloy J-	31D-020 MSL	L Kanng		ess body 1	T *				ber of Reflow Cyc	ies
	•	n (Sn) - anneaieu	C	O Alloy	1			200		<u>IC</u>	30	second	<u>, 13</u>		
VEL 1 - MAXIMUM UME AU DEAK TEMDETATUTE UUTME SOIGETINE IS 10-50 SECONGS		ima at neak tampat	dunina1	domina ia 10-2	10 seconds										
or more information regarding material composition please refer to page 3															

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct at it in member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.42	mg	Supplier	Silicon (Si)	7440-21-3		0.42	mg
Die Attach	0.11	mg	Supplier	Silver (Ag)	7440-22-4		0.088	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.022	mg
Lead Frame	5.78	mg	Supplier	Silver (Ag)	7440-22-4		0.0705	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0069	mg
			Supplier	Iron (Fe)	7439-89-6		0.1358	mg
			Supplier	Copper (Cu)	7440-50-8		5.565	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0017	mg
Mold Compound-Black	7.34	mg		Epoxy resin	proprietary data		0.367	mg
			Supplier	Phenolic Resin	Proprietary Data		0.367	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1468	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0367	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.4225	mg
Plating	0.39	mg	Supplier	Tin (Sn)	7440-31-5		0.39	mg
Wire Bond - Au	0.04	mg	Supplier	Gold (Au)	7440-57-5		0.04	mg